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Dated: \_\_\_\_\_

Docket No.: 06026/100G081-US1  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Joseph Cachina et al.

Application No.: 10/019,507

Confirmation Number:

Filed: March 29, 2002

Art Unit: N/A

For: SOLDER-BEARING WAFER FOR USE IN  
SOLDERING OPERATIONS

Examiner: Not Yet Assigned

**SUBMISSION OF FORMAL DRAWINGS**

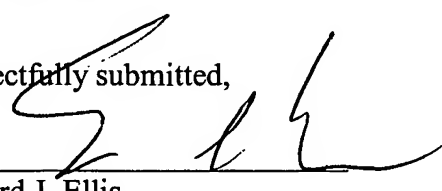
MS PGPUB Drawings  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Submitted herewith is one set (six sheets, figures 1-18) of formal drawings for filing in the above-identified patent application. Kindly substitute the enclosed formal drawings for the informal drawings submitted with the originally filed application.

Dated: October 7, 2004

Respectfully submitted,

By   
Edward J. Ellis

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